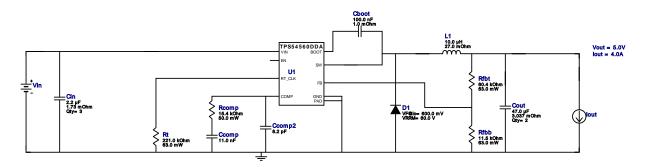
VinMin = 28.0V VinMax = 48.0V Vout = 5.0V Iout = 4.0A Device = TPS54560DDAR Topology = Buck Created = 2022-12-30 07:14:24.671 BOM Cost = \$5.14 BOM Count = 15 Total Pd = 2.8W

WEBENCH® Design Report

Design: 14 TPS54560DDAR
TPS54560DDAR 28V-48V to 5.00V @ 4A dodsfalla



Design Alerts

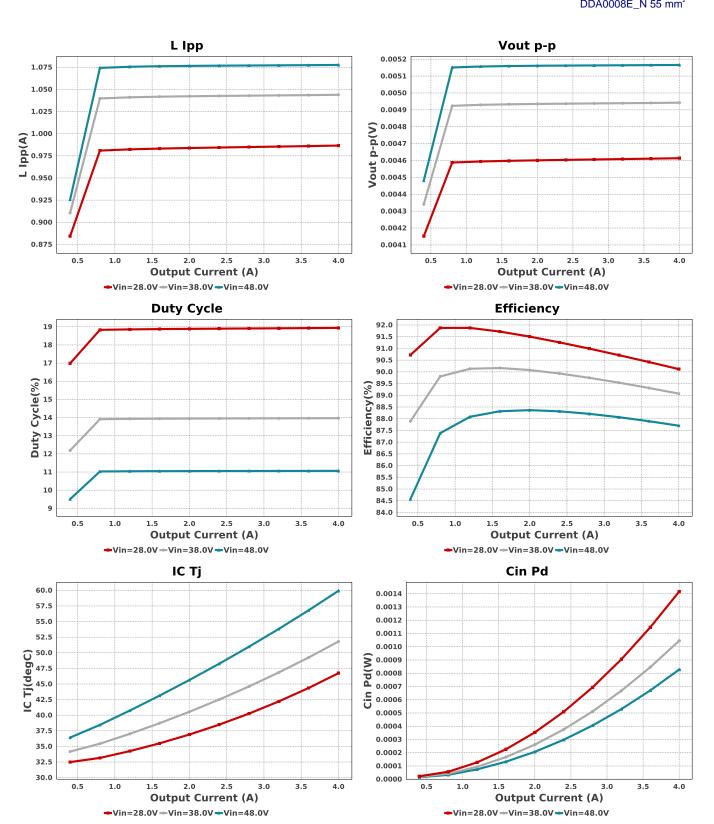
Component Selection Information

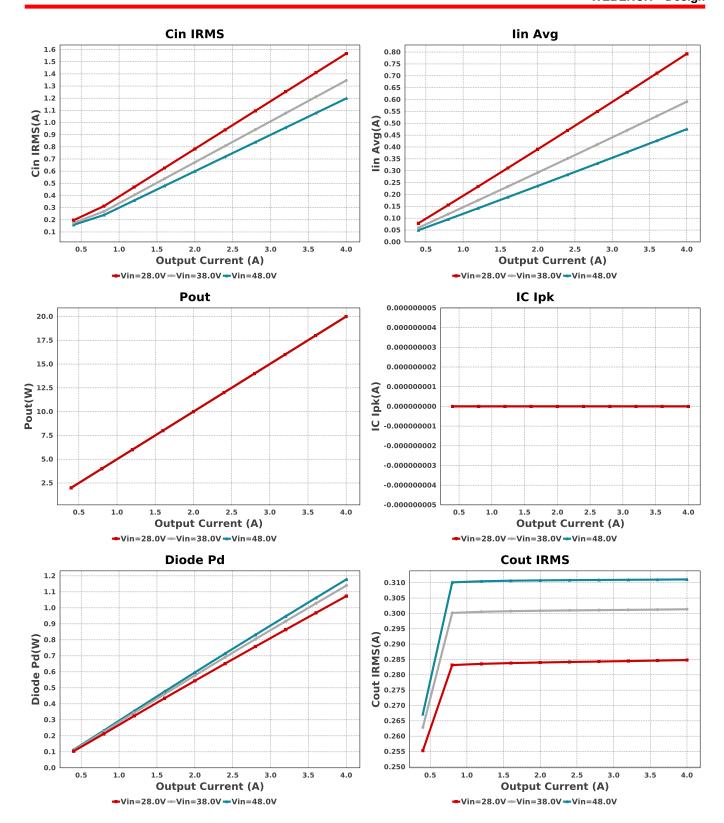
TI does not recommend using TPS54560 part in a new design. Please use TPS54560B which is an EXACT EQUIVALENT in functionality and parametrics to the compared device.

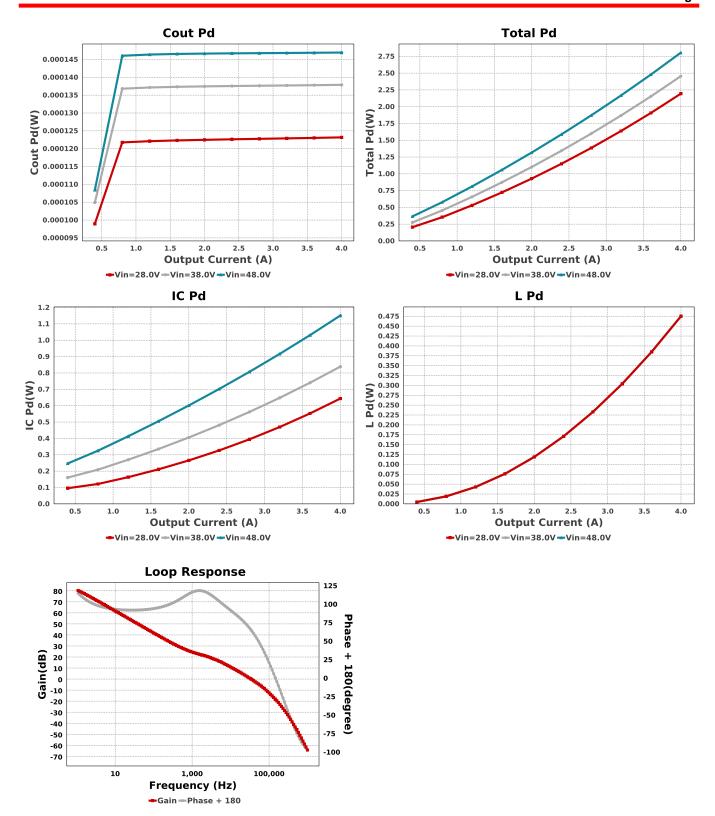
Electrical BOM

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot	MuRata	GRM155R71A104KA01D Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
Ccomp	Samsung Electro- Mechanics	CL32C113JBHNNNE Series= C0G/NP0	Cap= 11.0 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.42	1210 15 mm ²
Ccomp2	AVX	06031U8R2BAT2A Series= C0G/NP0	Cap= 8.2 pF VDC= 100.0 V IRMS= 0.0 A	1	\$0.06	0603 5 mm ²
Cin	TDK	C3225X7R2A225K230AB Series= X7R	Cap= 2.2 uF ESR= 1.73 mOhm VDC= 100.0 V IRMS= 5.5932 A	3	\$0.21	1210_250 15 mm ²
Cout	MuRata	GRM32ER61C476KE15L Series= X5R	Cap= 47.0 uF ESR= 3.037 mOhm VDC= 16.0 V IRMS= 4.59346 A	2	\$0.17	1210_280 15 mm ²
D1	Diodes Inc.	STPS30M60	VF@Io= 600.0 mV VRRM= 60.0 V	1	\$0.79	TO-220AB 79 mm ²
L1	Coilcraft	XAL6060-103MEB	L= 10.0 μH 27.0 mOhm	1	\$0.82	XAL6060 72 mm ²
Rcomp	Yageo	RC0201FR-0715K4L Series= ?	Res= 15.4 kOhm Power= 50.0 mW Tolerance= 1.0%	1	\$0.01	0201 2 mm ²
Rfbb	Vishay-Dale	CRCW040211K5FKED Series= CRCWe3	Res= 11.5 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Rfbt	Vishay-Dale	CRCW040260K4FKED Series= CRCWe3	Res= 60.4 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
Rt	Vishay-Dale	CRCW0402221KFKED Series= CRCWe3	Res= 221.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
U1	Texas Instruments	TPS54560DDAR	Switcher	1	\$2.03	DDA0009E N 55 mm²







Operating Values

	#	Name	Value	Category	Description
_	1.	Cin IRMS	1.198 A	Capacitor	Input capacitor RMS ripple current
	2.	Cin Pd	827.76 μW	Capacitor	Input capacitor power dissipation
	3.	Cout IRMS	311.073 mA	Capacitor	Output capacitor RMS ripple current
	4.	Cout Pd	146.94 μW	Capacitor	Output capacitor power dissipation
	5.	Diode Pd	1.177 W	Diode	Diode power dissipation
	6.	IC lpk	0.0 A	IC	Peak switch current in IC
	7.	IC Pd	1.151 W	IC	IC power dissipation
	8.	IC Tj	59.92 degC	IC	IC junction temperature
	9.	ICThetaJA Effective	26.0 degC/W	IC	Effective IC Junction-to-Ambient Thermal Resistance
	10.	lin Avg	475.09 mA	IC	Average input current
	11.	L lpp	1.078 A	Inductor	Peak-to-peak inductor ripple current

#	Name	Value	Category	Description
12.	L Pd	475.2 mW	Inductor	Inductor power dissipation
13.	Cin Pd	827.76 μW	Power	Input capacitor power dissipation
14.	Cout Pd	146.94 μW	Power	Output capacitor power dissipation
15.	Diode Pd	1.177 W	Power	Diode power dissipation
16.	IC Pd	1.151 W	Power	IC power dissipation
17.	L Pd	475.2 mW	Power	Inductor power dissipation
18.	Total Pd	2.804 W	Power	Total Power Dissipation
19.	BOM Count	15	System	Total Design BOM count
			Information	
20.	Cross Freq	34.225 kHz	System	Bode plot crossover frequency
			Information	
21.	Duty Cycle	11.065 %	System	Duty cycle
			Information	
22.	Efficiency	87.703 %	System	Steady state efficiency
			Information	
23.	FootPrint	313.0 mm ²	System	Total Foot Print Area of BOM components
			Information	
24.	Frequency	441.518 kHz	System	Switching frequency
			Information	
25.	Gain Marg	-18.351 dB	System	Bode Plot Gain Margin
			Information	
26.	lout	4.0 A	System	lout operating point
			Information	
27.	Low Freq Gain	80.15 dB	System	Gain at 1Hz
			Information	
28.	Mode	CCM	System	Conduction Mode
			Information	
29.	Phase Marg	65.158 deg	System	Bode Plot Phase Margin
			Information	
30.	Pout	20.0 W	System	Total output power
			Information	
31.	Total BOM	\$5.143	System	Total BOM Cost
			Information	
32.	Vin	48.0 V	System	Vin operating point
			Information	
33.	Vout	5.0 V	System	Operational Output Voltage
			Information	
34.	Vout Actual	5.002 V	System	Vout Actual calculated based on selected voltage divider resistors
			Information	
35.	Vout Tolerance	2.714 %	System	Vout Tolerance based on IC Tolerance (no load) and voltage divider
			Information	resistors if applicable
36.	Vout p-p	5.166 mV	System	Peak-to-peak output ripple voltage
			Information	

Design Inputs

Name	Value	Description	
lout	4.0	Maximum Output Current	
VinMax	48.0	Maximum input voltage	
VinMin	28.0	Minimum input voltage	
Vout	5.0	Output Voltage	
base_pn	TPS54560	Base Product Number	
source	DC	Input Source Type	
Та	30.0	Ambient temperature	

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 28.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



Design Assistance

- 1. TI does not recommend using TPS54560 part in a new design. Please use TPS54560B which is an EXACT EQUIVALENT in functionality and parametrics to the compared device.
- 2. Master key: E4B9CFD1C57BC38D[v1]
- 3. TPS54560 Product Folder: http://www.ti.com/product/TPS54560: contains the data sheet and other resources.

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